



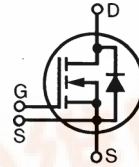
# CoolMOS Power MOSFET

IXKN 75N60C

|           |           |              |
|-----------|-----------|--------------|
| $V_{DSS}$ | $I_{D25}$ | $R_{DS(on)}$ |
| 600 V     | 75 A      | 35 mΩ        |

N-Channel Enhancement Mode  
Low  $R_{DS(on)}$ , High  $V_{DSS}$  MOSFET

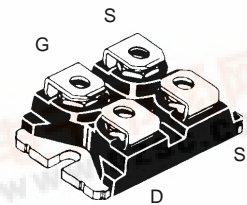
Preliminary



**COOLMOS**  
Power Semiconductors

| MOSFET    |  |                 |
|-----------|--|-----------------|
| Symbol    | Conditions   | Maximum Ratings |
| $V_{DSS}$ | $T_{VJ} = 25^{\circ}\text{C}$ to $150^{\circ}\text{C}$   | 600 V           |
| $V_{GS}$  |  | $\pm 20$ V      |
| $I_{D25}$ | $T_C = 25^{\circ}\text{C}$   | 75 A            |
| $I_{D90}$ | $T_C = 90^{\circ}\text{C}$   | 50 A            |
| $dv/dt$   | $V_{DS} < V_{DSS}$ ; $I_F \leq 100\text{A}$ ; $ di_F/dt  \leq 200\text{A}/\mu\text{s}$<br>$T_{VJ} = 150^{\circ}\text{C}$ | 6 V/ns          |
| $E_{AS}$  | $I_D = 10\text{A}$ ; $L = 36\text{mH}$ ; $T_C = 25^{\circ}\text{C}$  | 1.8 J           |
| $E_{AR}$  | $I_D = 20\text{A}$ ; $L = 5\mu\text{H}$ ; $T_C = 25^{\circ}\text{C}$   | 1 mJ            |

miniBLOC, SOT-227 B  
E72873



G = Gate  
S = Source

D = Drain

Either source terminal at miniBLOC can be used as main or kelvin source

| Symbol  | Conditions  | Characteristic Values<br>( $T_{VJ} = 25^{\circ}\text{C}$ , unless otherwise specified) |      |          |
|---|---|--|------|----------|
|   |   | min.   | typ. | max.     |
| $R_{DS(on)}$                                  | $V_{GS} = 10\text{V}$ ; $I_D = I_{D90}$   |  | 30   | 35 mΩ    |
| $V_{GS(th)}$                                  | $V_{DS} = 20\text{V}$ ; $I_D = 5\text{mA}$  | 3.5  |      | 5.5 V    |
| $I_{DSS}$                                     | $V_{DS} = V_{DSS}$ ; $V_{GS} = 0\text{V}$ ; $T_{VJ} = 25^{\circ}\text{C}$<br>$T_{VJ} = 125^{\circ}\text{C}$ |  | 0.1  | 0.05 mA  |
| $I_{GSS}$                                     | $V_{GS} = \pm 20\text{V}$ ; $V_{DS} = 0\text{V}$  |  |      | 200 nA   |
| $Q_g$<br>$Q_{gs}$<br>$Q_{gd}$                 | $V_{GS} = 10\text{V}$ ; $V_{DS} = 350\text{V}$ ; $I_D = 100\text{A}$  |  | 440  | nC       |
|   |   |  | 112  | nC       |
|   |   |  | 246  | nC       |
| $t_{d(on)}$<br>$t_r$<br>$t_{d(off)}$<br>$t_f$ | $V_{GS} = 10\text{V}$ ; $V_{DS} = 380\text{V}$ ;<br>$I_D = 50\text{A}$ ; $R_G = 1\Omega$                    |  | 30   | ns       |
|   |   |  | 95   | ns       |
|   |   |  | 100  | ns       |
|   |   |  | 10   | ns       |
| $V_F$   | (reverse conduction) $I_F = 37.5\text{A}$ ; $V_{GS} = 0\text{V}$  | 0.9  |      | 1.1 V    |
| $R_{thJC}$                                    |   |  |      | 0.22 K/W |

### Features

- miniBLOC package
  - Electrically isolated copper base
  - Low coupling capacitance to the heatsink for reduced EMI
  - High power dissipation due to AlN ceramic substrate
  - International standard package SOT-227
  - Easy screw assembly
- fast CoolMOS power MOSFET - 2<sup>nd</sup> generation
  - High blocking capability
  - Low on resistance
  - Avalanche rated for unclamped inductive switching (UIS)
  - Low thermal resistance due to reduced chip thickness
- Enhanced total power density

### Applications

- Switched mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)
- Power factor correction (PFC)
- Welding
- Inductive heating

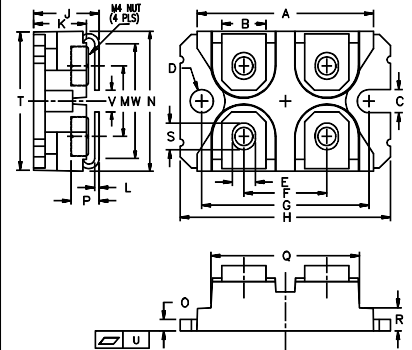
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Infineon Technologies AG.

### Component

| Symbol     | Conditions                                     | Maximum Ratings |    |
|------------|--|-----------------|----|
| $V_{ISOL}$ | $I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$ | 2500            | V~ |
| $T_{VJ}$   |  | -40...+150      | °C |
| $T_{stg}$  |  | -40...+125      | °C |
| $M_d$      | mounting torque                                | 1.5             | Nm |
|            | terminal connection torque (M4)                | 1.5             | Nm |

| Symbol        | Conditions             | Characteristic Values |      |      |
|---------------|------------------------|-----------------------|------|------|
|               |                        | min.                  | typ. | max. |
| $R_{thCH}$    | with heatsink compound |                       | 0.1  | K/W  |
| <b>Weight</b> |                        |                       | 30   | g    |

### miniBLOC, SOT-227 B



M4 screws (4x) supplied

| Dim. | Millimeter |       | Inches |       |
|------|------------|-------|--------|-------|
|      | Min.       | Max.  | Min.   | Max.  |
| A    | 31.50      | 31.88 | 1.240  | 1.255 |
| B    | 7.80       | 8.20  | 0.307  | 0.323 |
| C    | 4.09       | 4.29  | 0.161  | 0.169 |
| D    | 4.09       | 4.29  | 0.161  | 0.169 |
| E    | 4.09       | 4.29  | 0.161  | 0.169 |
| F    | 14.91      | 15.11 | 0.587  | 0.595 |
| G    | 30.12      | 30.30 | 1.186  | 1.193 |
| H    | 37.80      | 38.20 | 1.489  | 1.505 |
| J    | 11.68      | 12.22 | 0.460  | 0.481 |
| K    | 8.92       | 9.60  | 0.351  | 0.378 |
| L    | 0.76       | 0.84  | 0.030  | 0.033 |
| M    | 12.60      | 12.85 | 0.496  | 0.506 |
| N    | 25.15      | 25.42 | 0.990  | 1.001 |
| O    | 1.98       | 2.13  | 0.078  | 0.084 |
| P    | 4.95       | 5.97  | 0.195  | 0.235 |
| Q    | 26.54      | 26.90 | 1.045  | 1.059 |
| R    | 3.94       | 4.42  | 0.155  | 0.174 |
| S    | 4.72       | 4.85  | 0.186  | 0.191 |
| T    | 24.59      | 25.07 | 0.968  | 0.987 |
| U    | -0.05      | 0.1   | -0.002 | 0.004 |
| V    | 3.30       | 4.57  | 0.130  | 0.180 |
| W    | 0.780      | 0.830 | 0.031  | 0.033 |

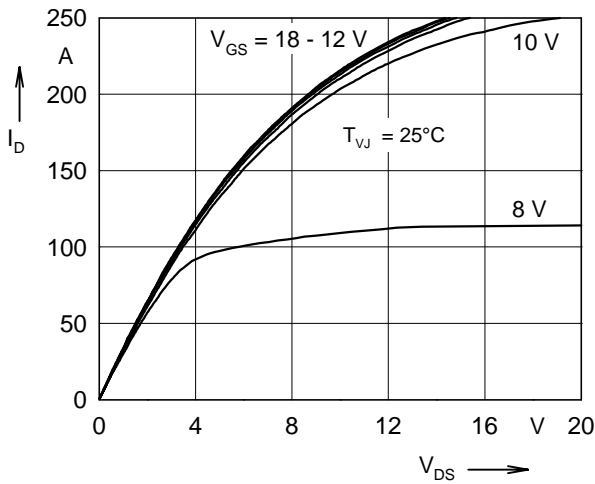


Fig. 1: typ. Output Characteristics

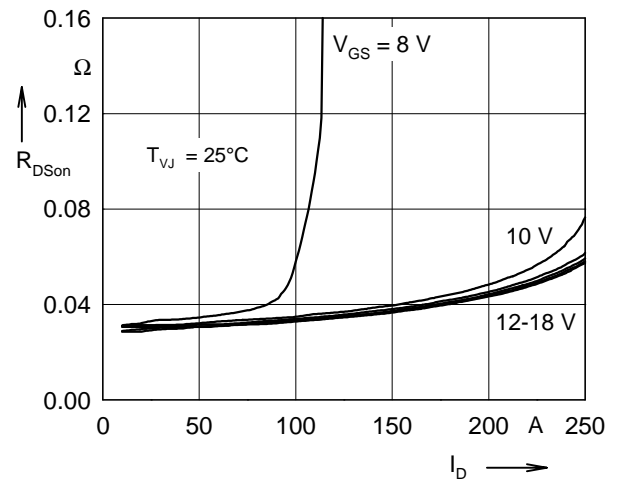


Fig. 2: typ.  $R_{DS(on)}$  vs. Drain Current

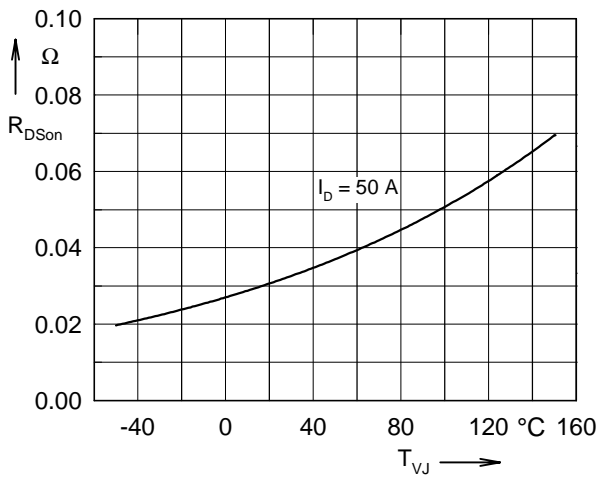


Fig. 3: typ.  $R_{DS(on)}$  vs. Junction Temperature

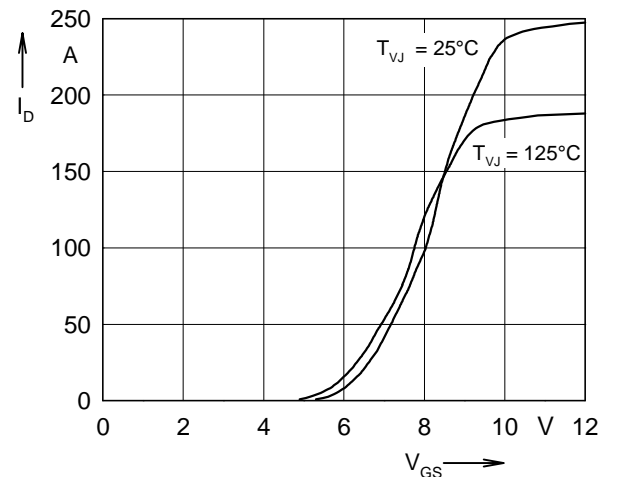


Fig. 4: typ. Input Admittance

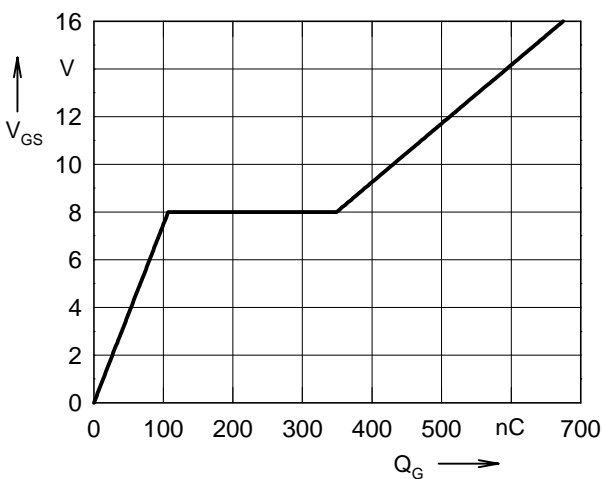


Fig. 5: typ. Gate Charge Characteristic Curve

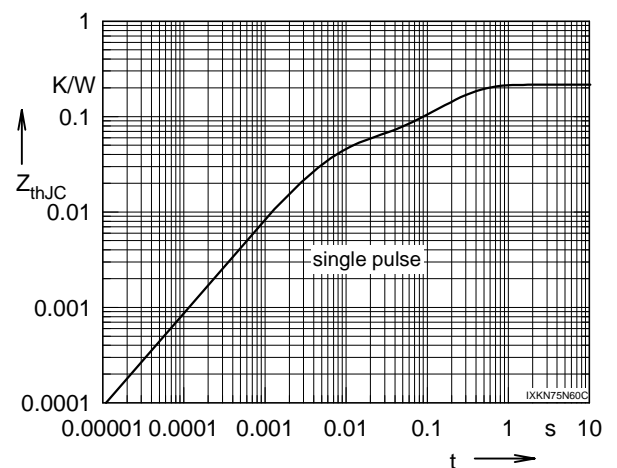


Fig. 6: typ. Transient Thermal Impedance